N-Channel Power MOSFET 600 V, 4.8 Ω

Features

- Low ON Resistance
- Low Gate Charge
- ESD Diode–Protected Gate
- 100% Avalanche Tested
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



ON Semiconductor®

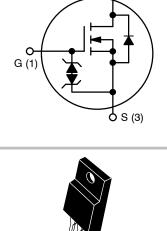
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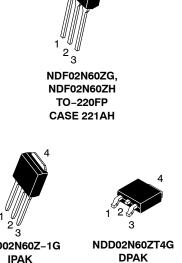
V _{DSS}	R _{DS(on)} (MAX) @ 1 A
600 V	4.8 Ω

N-Channel D (2)

Rating	Symbol	NDF	NDF NDD		
Drain-to-Source Voltage	V _{DSS}	60	0	V	
Continuous Drain Current $R_{\theta JC}$ (Note 1)	۱ _D	2.4	2.2	A	
Continuous Drain Current $R_{\theta JC}$ T _A = 100°C (Note 1)	۱ _D	1.6	1.4	A	
Pulsed Drain Current, V _{GS} @ 10 V	I _{DM}	10	9	Α	
Power Dissipation $R_{\theta JC}$	er Dissipation $R_{\theta JC}$ P_D 24 57		57	W	
Gate-to-Source Voltage	V _{GS}	±3	±30		
Single Pulse Avalanche Energy, $I_D = 2.4 A$	E _{AS}	120		mJ	
ESD (HBM) (JESD 22–A114)	V _{esd}	2500		V	
RMS Isolation Voltage (t = 0.3 sec., R.H. \leq 30%, T _A = 25°C) (Figure 17)	0.3 sec., R.H. ≤ 30%, 25°C) (Figure 17)			V	
Peak Diode Recovery (Note 2)	dv/dt	4.5	5	V/ns	
Continuous Source Current (Body Diode)	I _S	2.4		A	
Maximum Temperature for Soldering Leads	ΤL	260		°C	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	–55 tc	150	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)





NDD02N60Z-1G IPAK CASE 369D

CASE 369AA

ORDERING AND MARKING INFORMATION

See detailed ordering, marking and shipping information on page 7 of this data sheet.

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assumed, damage may occur and reliability may be affected.

2. $I_{SD} = 2.4$ Å, di/dt ≤ 100 Å/ μ s, $V_{DD} \leq BV_{DSS}$, $T_J = +150^{\circ}C$

1. Limited by maximum junction temperature

THERMAL RESISTANCE

Parameter		Symbol	Value	Unit
Junction-to-Case (Drain)	NDF02N60Z NDD02N60Z	$R_{\theta JC}$	4.9 2.2	°C/W
Junction-to-Ambient Steady State	(Note 3) NDF02N60Z (Note 4) NDD02N60Z (Note 3) NDD02N60Z-1	$R_{ heta JA}$	51 41 80	

3. Insertion mounted

4. Surface mounted on FR4 board using 1" sq. pad size, (Cu area = 1.127 in sq [2 oz] including traces).

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Characteristic	Test Conditions	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 1 mA$		BV _{DSS}	600			V
Breakdown Voltage Temperature Coeffi- cient	Reference to 25°C I _D = 1 mA	Э,	$\Delta BV_{DSS}/\Delta T_{J}$		0.6		V/°C
Drain-to-Source Leakage Current	<u> </u>	25°C	I _{DSS}			1	μΑ
	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	150°C				50	
Gate-to-Source Forward Leakage	V _{GS} = ±20 V		I _{GSS}			±10	μΑ
ON CHARACTERISTICS (Note 5)							
Static Drain-to-Source On-Resistance	V _{GS} = 10 V, I _D = 1.0	A (R _{DS(on)}		4.0	4.8	Ω
Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 50 μ A		V _{GS(th)}	3.0	4.0	4.5	V
Forward Transconductance	V _{DS} = 15 V, I _D = 1.2 A		g fs		1.7		S
DYNAMIC CHARACTERISTICS							
Input Capacitance (Note 6)	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		C _{iss}	215	274	325	pF
Output Capacitance (Note 6)			C _{oss}	25	34	45	
Reverse Transfer Capacitance (Note 6)			C _{rss}	4.0	7.0	10	
Total Gate Charge (Note 6)			Qg	5.0	10	16	nC
Gate-to-Source Charge (Note 6)	V _{DD} = 300 V, I _D = 2.	4 A,	Q _{gs}	1.5	2.4	4.0	
Gate-to-Drain ("Miller") Charge (Note 6)	V _{GS} = 10 V		Q _{gd}	3.5	5.3	8.0	
Plateau Voltage			V _{GP}		6.4		V
Gate Resistance			Rg		4.9		Ω
RESISTIVE SWITCHING CHARACTERIST	ICS					•	
Turn-On Delay Time			t _{d(on)}		9.0		ns
Rise Time	V _{DD} = 300 V, I _D = 2.	4 A,	t _r		7.0		1
Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 5$		t _{d(off)}		15		
Fall Time	1		t _f		7.0		1
SOURCE-DRAIN DIODE CHARACTERIS	TICS (T _C = 25°C unless other	erwise not	ed)				
Diode Forward Voltage	I _S = 2.4 A, V _{GS} = 0		V _{SD}			1.6	V

 V_{GS} = 0 V, V_{DD} = 30 V I_S = 2.4 A, di/dt = 100 A/ μs Q_{rr} Reverse Recovery Charge 0.7 μC Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

t_{rr}

240

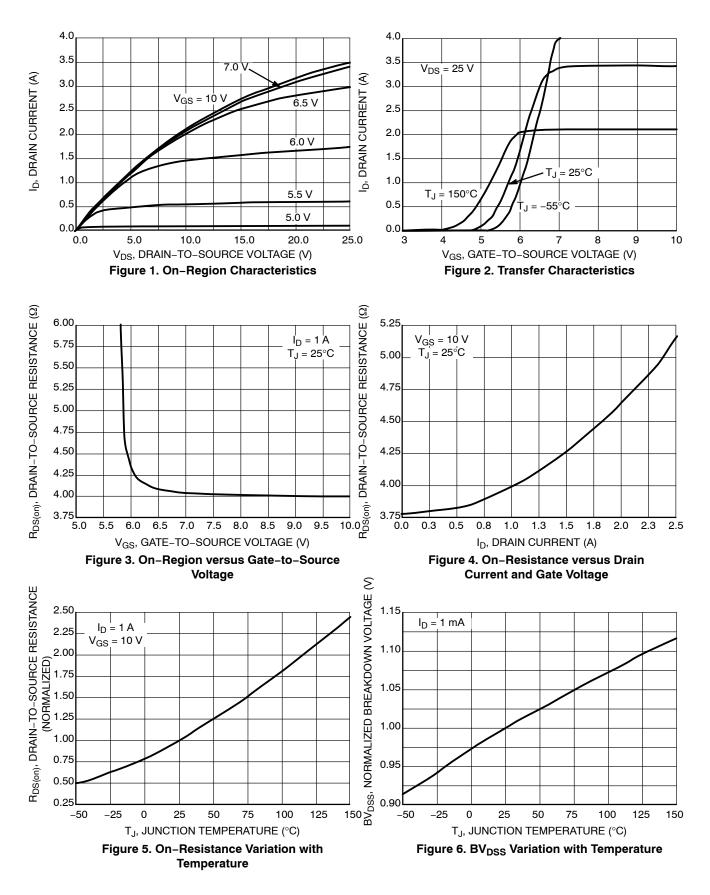
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performance may not be indicated by the Electrical Characteristics if operated under different conditions.

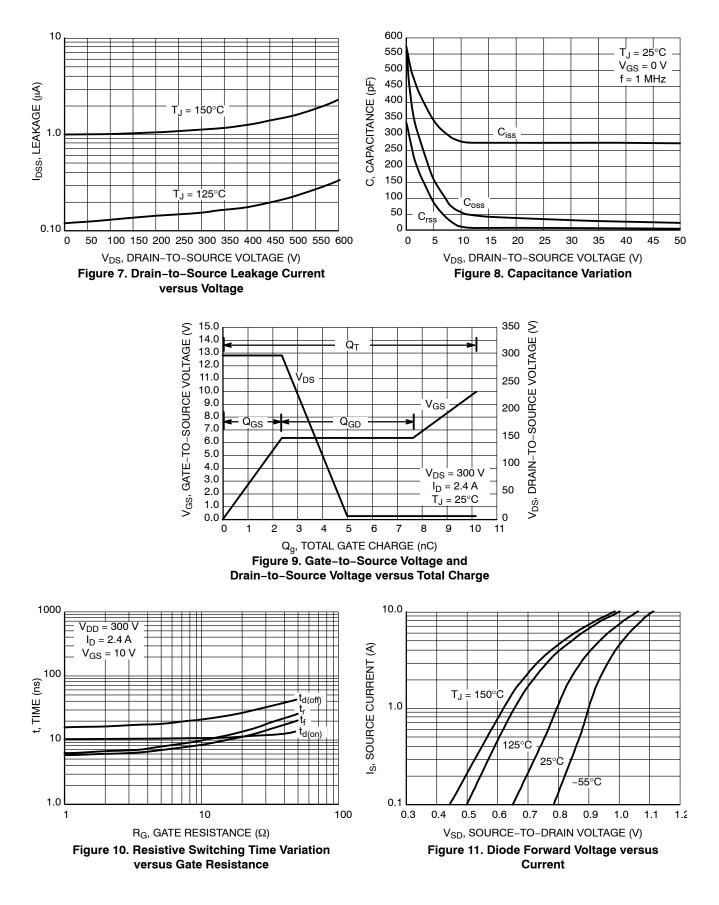
5. Pulse Width \leq 380 µs, Duty Cycle \leq 2%. 6. Guaranteed by design.

Reverse Recovery Time

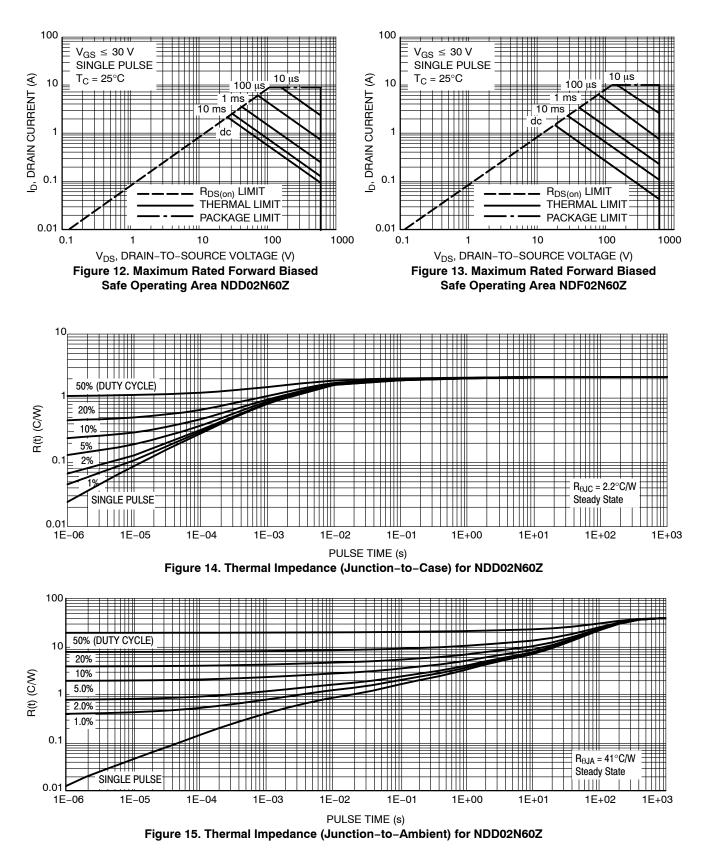
TYPICAL CHARACTERISTICS

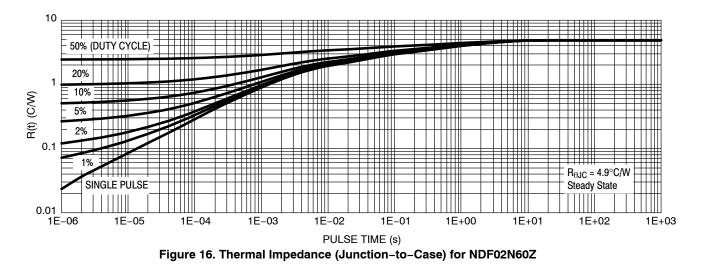


TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





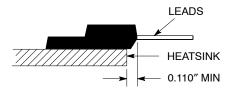


Figure 17. Isolation Test Diagram

Measurement made between leads and heatsink with all leads shorted together.

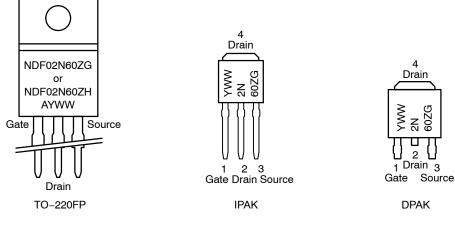
*For additional mounting information, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ORDERING INFORMATION

Order Number	Package	Shipping [†]
NDF02N60ZG	TO-220FP (Pb-Free, Halogen-Free)	50 Units / Rail
NDF02N60ZH	TO-220FP (Pb-Free, Halogen-Free)	50 Units / Rail
NDD02N60Z-1G	IPAK (Pb-Free, Halogen-Free)	75 Units / Rail
NDD02N60ZT4G	DPAK (Pb-Free, Halogen-Free)	2500 / Tape and Reel

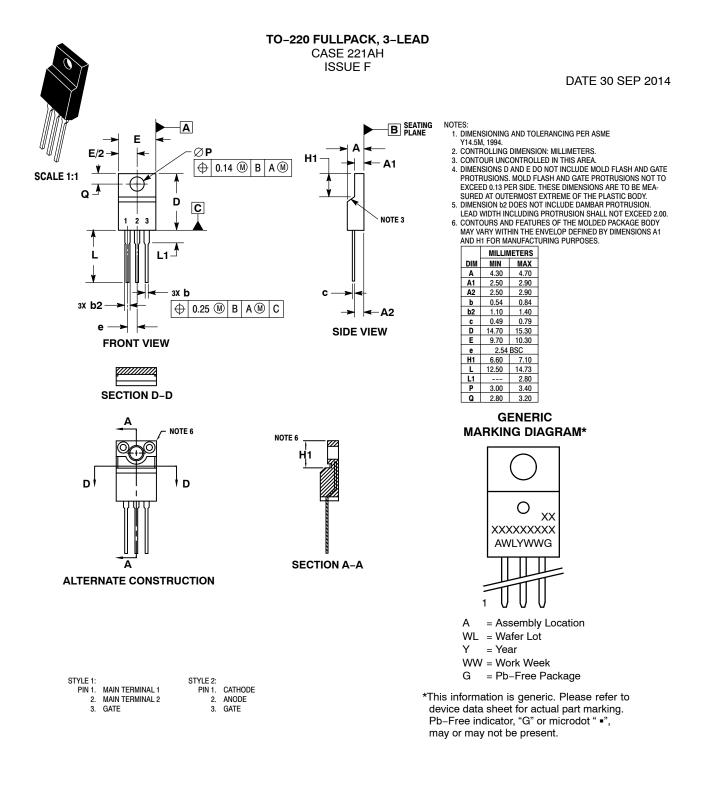
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MARKING DIAGRAMS



- A = Location Code
- Y = Year
- WW = Work Week
- G, H = Pb-Free, Halogen-Free Package

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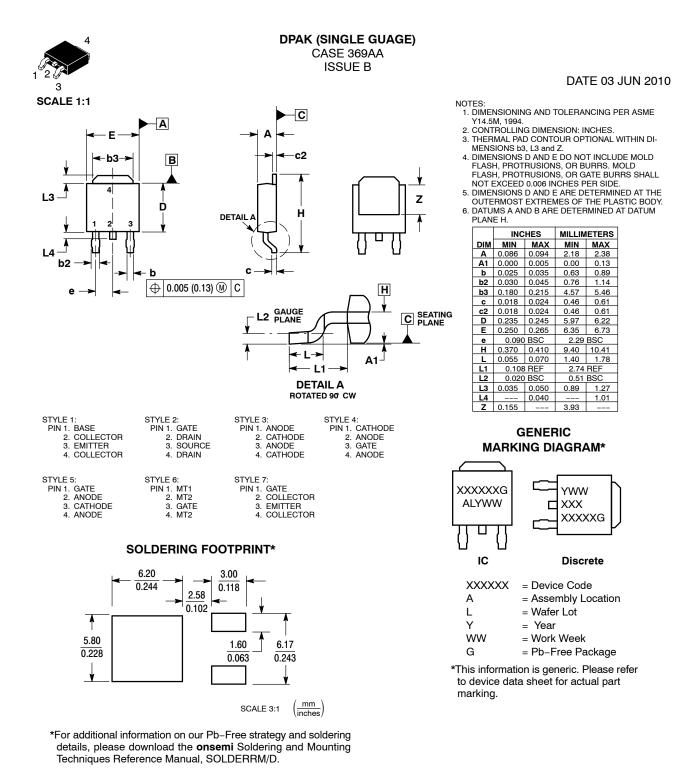
DPAK INSERTION MOUNT CASE 369 ISSUE O DATE 02 JAN 2000 SCALE 1:1 С $B \rightarrow$ NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. Е R MILLIMETERS INCHES л DIM MIN MAX MIN MAX A 0.235 0.250 B 0.250 0.265 5.97 6.35 Δ 6.35 6.73 C 0.086 0.094 D 0.027 0.035 2.19 0.69 2.38 2 3 0.88 S E 0.033 0.040 F 0.037 0.047 0.84 1.01 0.94 -T-1.19 G 0.090 BSC 2.29 BSC SEATING H 0.034 0.040 J 0.018 0.023 0.87 1.01 0.46 0.58 K 0.350 0.380 8.89 9.65 **R** 0.175 0.215 4.45 5.46 0.050 0.090 1.27 J S 2.28 F V 0.030 0.050 н 0.77 1.27 D 3 PL G 🔫 ⊕ 0.13 (0.005) M T

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:		STYLE 5:		STYLE 6:	
PIN 1.	BASE	PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	GATE	PIN 1.	MT1
2.	COLLECTOR	2.	DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE	2.	MT2
3.	EMITTER	3.	SOURCE	3.	ANODE	3.	GATE	3.	CATHODE	3.	GATE
4.	COLLECTOR	4.	DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE	4.	MT2

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